

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of: Tomoo IJIMA et al.

Serial Number: 09/466,895 ✓

Filed: December 20, 1999

JAN 22 2002

TC 3700 MAIL ROOM

Group Art Unit: 3729

Examiner: S. SMITH

For: WIRING SUBSTRATE FOR MOUNTING  
SEMICONDUCTOR ELEMENTS AND  
FABRICATING METHOD THEREOF



AMENDMENT UNDER 37 CFR §1.111

Commissioner for Patents  
Washington, D.C. 20231  
Sir:

January 14, 2002

In response to the Office Action dated September 14, 2001, extended to January 14, 2002 by a one-month Petition for Extension of Time, please amend the above-identified application as follows:

IN THE TITLE:

Amend the title to read as follows:

METHOD FOR FABRICATING A WIRING SUBSTRATE

IN THE ABSTRACT:

Delete the current Abstract and replace therewith the attached substitute Abstract.

IN THE CLAIMS:

Please cancel claims 1 and 3-14 without prejudice or disclaimer.

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